

L Number	Hits	Search Text	DB	Time stamp
77	1	("6022804").PN.	USPAT	2003/04/19 17:48
78	2	("4840923"   "4872050").PN.	USPAT	2003/04/19 17:48
79	1	("5656545").PN.	USPAT	2003/04/19 17:50
80	67	((cmp or (chemical near polish\$3)) near (plug or plugs)) and oxide	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/04/19 18:12
81	54	((((cmp or (chemical near polish\$3)) near (plug or plugs)) and oxide) and (@ad<20010713)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/04/19 18:26
82	285	((etch or etching) near (plug or plugs)) and oxide	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/04/19 18:23
83	169	((((etch or etching) near (plug or plugs)) and oxide ) and (cmp or (chemical near polish\$3))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/04/19 18:12
84	124	(((((etch or etching) near (plug or plugs)) and oxide ) and (cmp or (chemical near polish\$3))) and (@ad<20010713)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/04/19 18:17
85	426	sin near (insulat\$3 or dielectric)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/04/19 18:18
86	196	((etch or etching) and (cmp or polish or polishing) near oxide) and (plug or plugs)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/04/19 18:24
87	158	((((etch or etching) and (cmp or polish or polishing) near oxide) and (plug or plugs)) and (@ad<20010713)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/04/19 18:27